



**News Release September 2008**

**"Inseto Sign Exclusive Distribution Agreement  
With Kulicke & Soffa For The UK & Ireland"**

Kulicke & Soffa GHC (K&S [www.kns.com](http://www.kns.com)) has appointed Inseto [www.inseto.co.uk](http://www.inseto.co.uk), a leading supplier of equipment & materials for Microelectronic & Semiconductor Assembly, as their new exclusive distributor in the UK & Ireland.

From its headquarters in Andover, Inseto will supply and support the complete Kulicke & Soffa product range, which features the Micro-Swiss brand of Bonding Capillaries & Wedge Tools, Manual Wire Bonding Equipment for Ball and Wedge Bonding, Automatic Ball Bonding & Bump Bonding Machines, Die Bonding Systems and Hub Dicing Blades.

"The K&S brand is an excellent addition to the Inseto portfolio", says Inseto Sales Director, Matthew Brown. "K&S products have a great reputation, and it is our intention to build on this foundation and provide the higher levels of customer service and support, to make K&S products an automatic first choice for our customers".

"K&S is very pleased to announce our new partnership with Inseto" commented Siegfried Haggemiller, European Sales Director for K&S. "With this new arrangement we expect to increase the level of sales and service offered to existing and potential customers, plus benefit from Inseto's proficient customer support infrastructure".

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*About Inseto:* Inseto is a leading distributor of advanced manufacturing equipment & consumable products used in the assembly of semiconductor & microelectronic devices. The products, which are available throughout the UK & Ireland from specialist divisions, include equipment for wafer inspection & dicing, die bonding and microsystems assembly, manual & automatic wire bonders, wire bond pull and shear testers, to mixed signal test equipment; plus a comprehensive range of complementary assembly consumables including bonding wires & ribbons, precision stampings, preforms, hermetic glass & ceramic packages, thick film materials, metalised thin film and dicing consumables.



*About K&S:* Kulicke & Soffa (NASDAQ:KLIC) is the world's leading supplier of semiconductor assembly equipment, materials, and technology. K&S provides wire bonders, capillaries, wire, die bonders, and die collets for all types of semiconductor packages using wire as the internal electrical interconnections. K&S is the only major supplier to the semiconductor assembly industry that provides customers with semiconductor assembly equipment along with the complementing packaging materials and process technology that enable our customers to achieve the highest possible yields and throughput. The ability to provide these assembly related products is unique to Kulicke & Soffa, and allows us to develop system solutions to the new technology challenges inherent in assembling and packaging next-generation semiconductor devices.

Further information on Inseto & Kulicke & Soffa can be found on our respective websites: [www.inseto.co.uk](http://www.inseto.co.uk) or [www.kns.com](http://www.kns.com)

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